# 507185031 03/18/2022 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT	
NATURE OF CONVEYANCE:		ASSIGNMENT	
CONVEYING PARTY	/ DATA		
		Name	Execution Date
KAZUTAKE TANIGUCHI			10/21/2019
HIROAKI SHISHIDO			10/01/0010
			10/21/2019
RECEIVING PARTY	DATA	ORPORATION	10/21/2019
RECEIVING PARTY	DATA HOYA C	ORPORATION IISHI-SHINJUKU, SHINJUKU-KU	10/21/2019
RECEIVING PARTY Name:	DATA HOYA C		10/21/2019
RECEIVING PARTY Name: Street Address:	DATA HOYA C 6-10-1 N		10/21/2019

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17698151

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DATE SIGNED:	03/18/2022	
Total Attachments: 2	103887-MASKRI ANKS002610115-1308244#page1 tif	

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### Attorney Docket No. 103887-MASKBLANKS002600US-1147393

### ASSIGNMENT

#### (Patent Application)

We, the undersigned, have invented certain inventions and improvements disclosed in a utility (provisional or non-provisional) or design patent application entitled

"MASK BLANK, TRANSFER MASK AND METHOD FOR PRODUCING SEMICONDUCTOR DEVICE,"

filed with the Receiving Office of Japan on February 28, 2018

and assigned international application no. PCT/JP2018/007475.

For one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which we acknowledge, we:

- Agree to assign, transfer, convey, and sell, hereby assign, transfer, convey, and sell and have assigned, transferred, conveyed, and sold to HOYA CORPORATION, a corporation of Japan having a principal place of business at 6-10-1 Nishi-Shinjuku, Shinjuku-Ku, Tokyo 1608347, Japan ("Assignee"), the entire right, title, and interest in and to:
  - (a) all intellectual property (including, without limitation, any innovation, information, invention, discovery, product, process, work or design) disclosed, embodied, shown, or claimed in the above-referenced patent application, implicitly or explicitly;
  - (b) the above-referenced patent application, and all applications based in whole or in part upon the above-referenced patent application, including, without limitation, all applications that are a provisional, non-provisional, design, divisional, continuation, continuation-in-part, registration, utility model, industrial design, reissue, renewal, substitute, extension, reexamination, post-grant review, inter partes review, supplemental examination or non-U.S. patent application or application for other rights based in whole or in part on the above-referenced patent application;
  - (c) the right to claim priority to the above-referenced patent application, and any and all applications referenced in subsection (b); and
  - (d) all patents (including, without limitation, all U.S. and non-U.S. patents, registrations, utility models, industrial designs, design patents, counterparts, continuations, continuations-in-part, divisionals, reissues, renewals, substitutes, extensions, reexaminations, post-grant reviews, inter partes reviews and supplemental examinations) that are granted or issued upon, or that claim priority to, any and all applications described in (b) of this paragraph or that disclose or claim intellectual property described in (a) of this paragraph, in whole or in part; and
  - (e) all claims for damages by reason of past infringement of any rights under the applications or patents described in (a), (b) or (c) of this paragraph (including

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provisional rights to reasonable royalties pursuant to 35 U.S.C. §154(d)) and the right to sue for and collect such damages and royalties for Assignee's own use.

- Authorize and request the U.S. Patent and Trademark Office or any other U.S. or non-U.S. agency to issue to the Assignee any and all patent(s), or other rights or documents, resulting from the intellectual property, patent application(s) and patents described in paragraph 1 of this Assignment.
- 3. Agree to sign all papers and documents, including without limitation, applications, declarations, oaths and petitions, and, at the Assignee's expense, perform any other acts that are necessary in connection with prosecution of patent application(s) or intellectual property described in paragraph 1 of this Assignment and the enforcement of patent(s) or other rights resulting from such patent application(s) or intellectual property.
- 4. Agree that the terms, covenants, and conditions of this Assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon us, as well as our heirs, legal representatives, and assigns.
- 5. Promise and affirm that we have not entered, and will not enter, into any assignment, contract, or understanding that conflicts with this Assignment.
- Authorize Kilpatrick Townsend & Stockton to insert above the application number and filing date of the above-described patent application when known.

Signed on the dates indicated beside our signatures.

Signature: Kazutake Tanjeuchi Date: October 21,2019 Kazutake TANIGUCHI

signature: Hiroak; Shishido

Date: October 21,2019

Hiroaki SHISHIDO

**RECORDED: 03/18/2022**